# International Rectifier

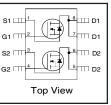
## **AUTOMOTIVE GRADE**

# AUIRF7103Q

HEXFET® Power MOSFET

#### **Features**

- Advanced Planar Technology
- Dual N Channel MOSFET
- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Lead-Free, RoHS Compliant
- Automotive Qualified\*



V <sub>(BR)DSS</sub>	50V
R <sub>DS(on)</sub> max.	130m $Ω$
I <sub>D</sub>	3.0A

#### **Description**

Specifically designed for Automotive applications, this cellular design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



#### **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T<sub>A</sub>) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I <sub>D</sub> @ T <sub>A</sub> = 25°C	Continuous Drain Current, V <sub>GS</sub> @ 4.5V	3.0	
I <sub>D</sub> @ T <sub>A</sub> = 70°C	Continuous Drain Current, V <sub>GS</sub> @ 4.5V	2.5	Α
I <sub>DM</sub>	Pulsed Drain Current ①	25	
P <sub>D</sub> @T <sub>A</sub> = 25°C	Power Dissipation ③	2.4	W
	Linear Derating Factor	16	W/°C
$V_{GS}$	Gate-to-Source Voltage	± 20	V
E <sub>AS</sub>	Single Pulse Avalanche Energy (Thermally Limited)	22	mJ
I <sub>AR</sub>	Avalanche Current ①	See Fig. 16c, 16d, 19, 20	Α
E <sub>AR</sub>	Repetitive Avalanche Energy ®		mJ
dv/dt	Peak Diode Recovery dv/dt ⑤	12	V/ns
T <sub>J</sub>	Operating Junction and	-55 to + 175	°C
T <sub>STG</sub>	Storage Temperature Range		

#### **Thermal Resistance**

	Parameter	Тур.	Max.	Units
$R_{\theta JL}$	Junction-to-Drain Lead		20	°C/W
$R_{\theta JA}$	Junction-to-Ambient   ⑤		62.5	

HEXFET® is a registered trademark of International Rectifier.

<sup>\*</sup>Qualification standards can be found at http://www.irf.com/

### Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	50			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.057		V/°C	Reference to 25°C, I <sub>D</sub> = 1mA
D	Otatia Busin ta Ossura On Basintana			130		$V_{GS} = 10V, I_D = 3.0A$ ②
$R_{DS(on)}$	Static Drain-to-Source On-Resistance			200	mΩ	$V_{GS} = 4.5V, I_D = 1.5A$ ②
$V_{GS(th)}$	Gate Threshold Voltage	1.0		3.0	٧	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
gfs	Forward Transconductance	3.4			S	$V_{DS} = 15V, I_{D} = 3.0A$
I <sub>DSS</sub>	Drain-to-Source Leakage Current			2.0		$V_{DS} = 40V, V_{GS} = 0V$
				25	μΑ	$V_{DS} = 40V, V_{GS} = 0V, T_{J} = 55^{\circ}C$
I <sub>GSS</sub>	Gate-to-Source Forward Leakage			-100	<b>π</b> Λ	V <sub>GS</sub> = 20V
	Gate-to-Source Reverse Leakage			100	nA	V <sub>GS</sub> = -20V

# Dynamic Electrical Characteristics @ $T_J = 25$ °C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$Q_g$	Total Gate Charge		10	15		$I_D = 2.0A$
$Q_{gs}$	Gate-to-Source Charge		1.2		nC	$V_{DS} = 40V$
$Q_{gd}$	Gate-to-Drain ("Miller") Charge		2.8			V <sub>GS</sub> = 10V
t <sub>d(on)</sub>	Turn-On Delay Time		5.1			$V_{DD} = 25V$
t <sub>r</sub>	Rise Time		1.7			$I_{D} = 1.0A$
$t_{d(off)}$	Turn-Off Delay Time		15		ns	$R_G = 6.0\Omega$
t <sub>f</sub>	Fall Time		2.3			$R_D = 25\Omega$ ②
C <sub>iss</sub>	Input Capacitance		255			$V_{GS} = 0V$
C <sub>oss</sub>	Output Capacitance		69		pF	$V_{DS} = 25V$
C <sub>rss</sub>	Reverse Transfer Capacitance		29			f = 1.0MHz

#### **Diode Characteristics**

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			3.0		MOSFET symbol
	(Body Diode)			3.0	Α	showing the
I <sub>SM</sub>	Pulsed Source Current			10	_ ^	integral reverse
	(Body Diode) ①			—   12	12	p-n junction diode.
$V_{SD}$	Diode Forward Voltage			1.2	V	$T_J = 25^{\circ}C$ , $I_S = 1.5A$ , $V_{GS} = 0V$ ②
t <sub>rr</sub>	Reverse Recovery Time		35	53	ns	$T_J = 25^{\circ}C, I_F = 1.5A$
Q <sub>rr</sub>	Reverse Recovery Charge		45	67	nC	di/dt = 100A/μs ②
t <sub>on</sub>	Forward Turn-On Time	Intrinsic	turn-on	time is r	egligible	(turn-on is dominated by LS+LD)

#### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width  $\leq$  400 $\mu$ s; duty cycle  $\leq$  2%.
- ③ Surface mounted on 1 in square Cu board.
- $\mbox{ } \mbox{ } \$
- 6 Limited by  $T_{Jmax}$ , see Fig.16c, 16d, 19, 20 for typical repetitive avalanche performance.

# Qualification Information<sup>†</sup>

		Automotive (per AEC-Q101) ††			
Qualification	Level		This part number(s) passed Automotive qualification. IR's Consumer qualification level is granted by extension of the		
Moisture Sen	sitivity Level	SO-8 MSL1			
	Machine Model		Class M1A (+/- 50V) <sup>†††</sup> AEC-Q101-002		
ESD	Human Body Model		Class H0 (+/- 250V) <sup>†††</sup> AEC-Q101-001		
	Charged Device Model	Class C5 (+/- 1125V) <sup>†††</sup> AEC-Q101-005			
RoHS Compl	iant	Yes			

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/
- †† Exceptions to AEC-Q101 requirements are noted in the qualification report.
- ††† Highest passing voltage.

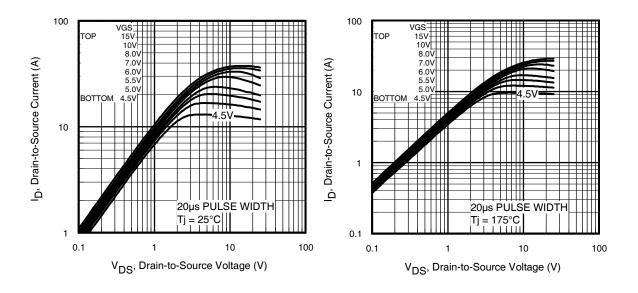


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics

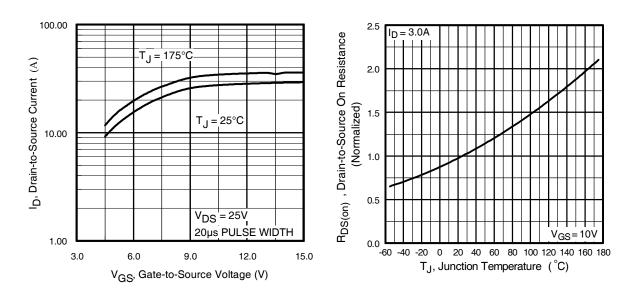
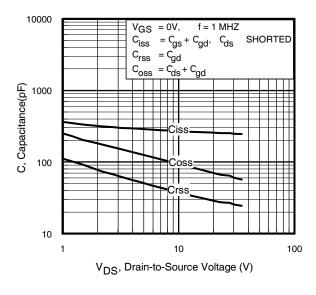
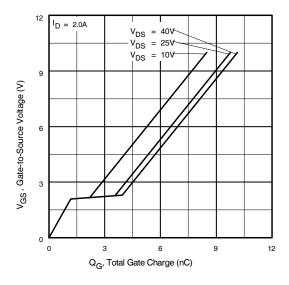


Fig 3. Typical Transfer Characteristics

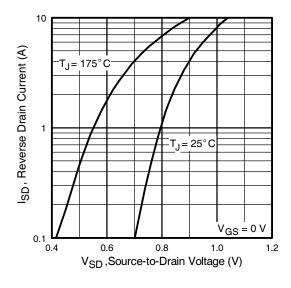
**Fig 4.** Normalized On-Resistance Vs. Temperature





**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage

**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage





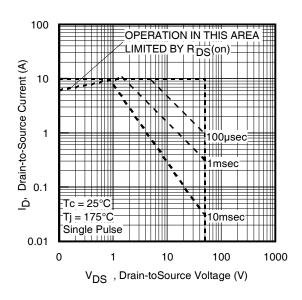
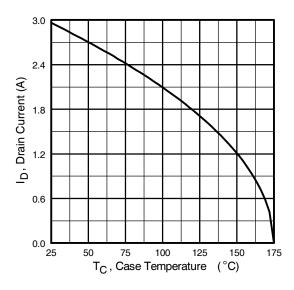


Fig 8. Maximum Safe Operating Area



**Fig 9.** Maximum Drain Current Vs. Case Temperature

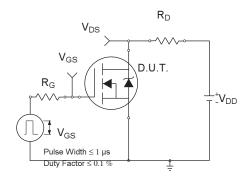


Fig 10a. Switching Time Test Circuit

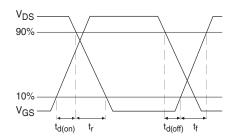


Fig 10b. Switching Time Waveforms

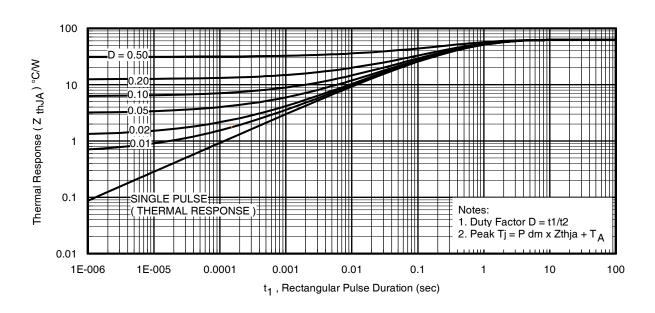
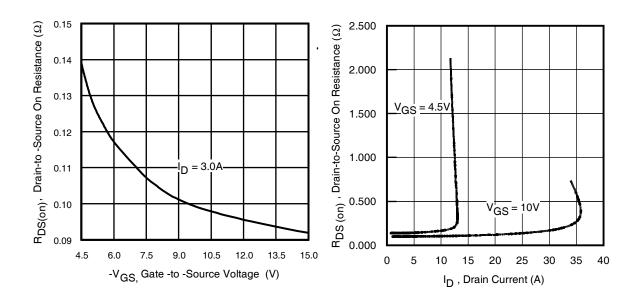
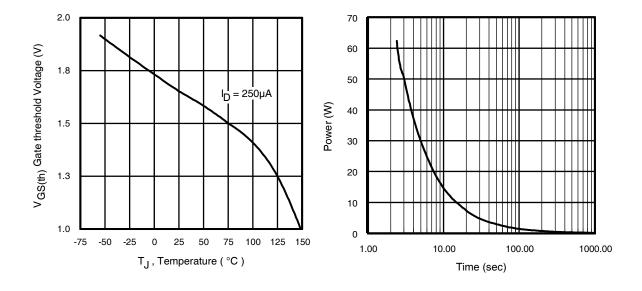


Fig 11. Typical Effective Transient Thermal Impedance, Junction-to-Ambient



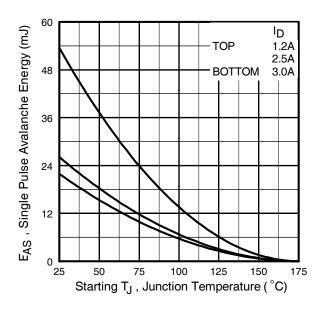
**Fig 12.** Typical On-Resistance Vs. Gate Voltage

**Fig 13.** Typical On-Resistance Vs. Drain Current



**Fig 14.** Typical Threshold Voltage Vs. Junction Temperature

Fig 15. Typical Power Vs. Time



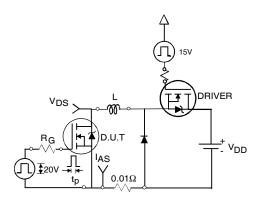


Fig 16c. Unclamped Inductive Test Circuit

**Fig 16a.** Maximum Avalanche Energy Vs. Drain Current

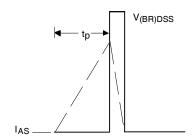


Fig 16d. Unclamped Inductive Waveforms

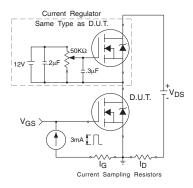


Fig 17. Gate Charge Test Circuit

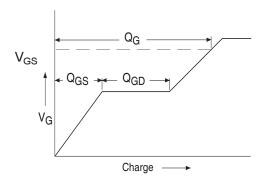


Fig 18. Basic Gate Charge Waveform

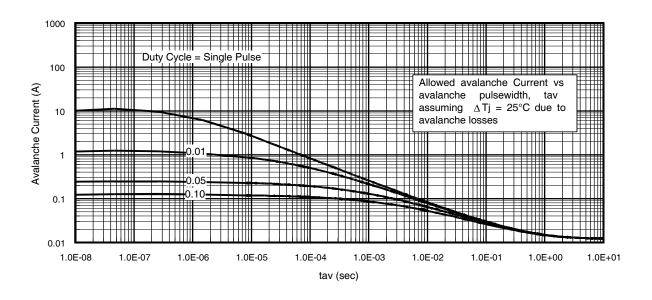


Fig 19. Typical Avalanche Current Vs. Pulsewidth

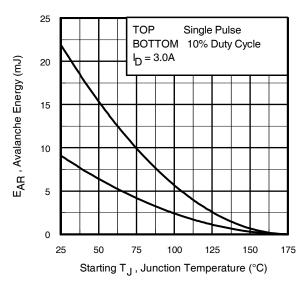


Fig 20. Maximum Avalanche Energy Vs. Temperature

#### Notes on Repetitive Avalanche Curves, Figures 15, 16: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
- Purely a thermal phenomenon and failure occurs at a temperature far in excess of T<sub>imax</sub>. This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long asTimax is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 12a, 12b.
- 4. P<sub>D (ave)</sub> = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I<sub>av</sub> = Allowable avalanche current.
- 7.  $\Delta T$  = Allowable rise in junction temperature, not to exceed T<sub>imax</sub> (assumed as 25°C in Figure 15, 16).  $t_{av}$  = Average time in avalanche.

 $D = Duty cycle in avalanche = t_{av} \cdot f$ 

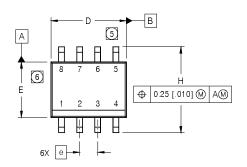
 $Z_{thJC}(D, t_{av})$  = Transient thermal resistance, see figure 11)

 $P_{D \text{ (ave)}} = 1/2 \text{ ( } 1.3 \cdot \text{BV-I}_{av} \text{)} = \triangle \text{T/ } Z_{thJC}$  $I_{av} = 2\Delta T / [1.3 \cdot BV \cdot Z_{th}]$  $E_{AS (AR)} = P_{D (ave)} \cdot t_{av}$ 

MILLIMETERS

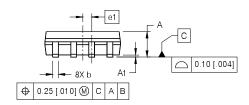
# **SO-8 Package Outline**

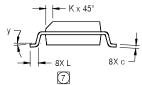
Dimensions are shown in millimeters (inches)



MIN	MAX	MIN	MAX	
.0532	.0688	1.35	1.75	
.0040	.0098	0.10	0.25	
.013	.020	0.33	0.51	
.0075	.0098	0.19	0.25	
.189	.1968	4.80	5.00	
.1497	.1574	3.80	4.00	
.050 B/	ASIC	1.27 BASIC		
.025 B	ASIC	0.635 E	BASIC	
.2284	.2440	5.80	6.20	
.0099	.0196	0.25	0.50	
.016	.050	0.40	1.27	
0°	8°	0°	8°	
	.0532 .0040 .013 .0075 .189 .1497 .050 B/ .025 B/ .2284 .0099	.0532 .0688 .0040 .0098 .013 .020 .0075 .0098 .189 .1968 .1497 .1574 .050 BASIC .025 BASIC .2284 .2440 .0099 .0196 .016 .050	.0532         .0688         1.35           .0040         .0098         0.10           .013         .020         0.33           .0075         .0098         0.19           .189         .1968         4.80           .497         .1574         3.80           .050 BASIC         1.27 B/           .025 BASIC         0.635 B           .2284         .2440         5.80           .0099         .0196         0.25           .016         .050         0.40	

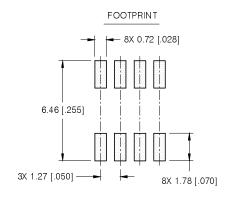
INCHES



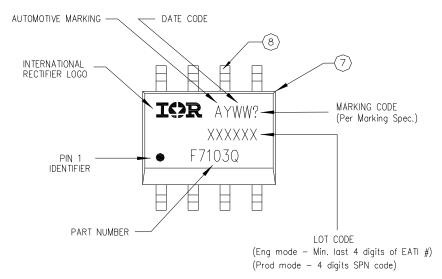


#### NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 [.006].
- 6 DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.010].
- (7) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.



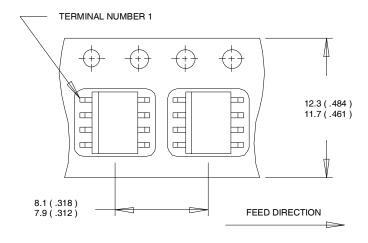
# **SO-8 Part Marking**



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/ 10

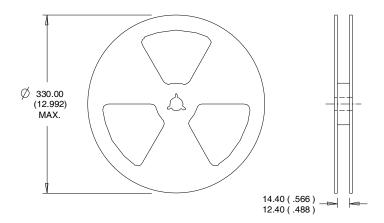
# **SO-8 Tape and Reel**

Dimensions are shown in millimeters (inches)



#### NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
   OUTLINE CONFORMS TO EIA-481 & EIA-541.



#### NOTES:

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

# AUIRF7103Q

International

TOR Rectifier

# **Ordering Information**

Base part number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF7103Q	SO-8	Tube	95	AUIRF7103Q
		Tape and Reel	4000	AUIRF7103QTR

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